



GP
ELECTRONICS

GP3439KDW

20V N- and P- Channel MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
20V	170mΩ@4.5V	0.75A
	230mΩ@2.5V	
	330mΩ@1.8V	
-20V	400mΩ@-4.5V	-0.66A
	570mΩ@-2.5V	
	810mΩ@-1.8V	

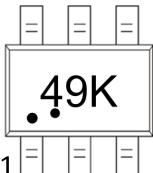
Feature

- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- ESD Protected Gate

Application

- Load Switch
- DC/DC Converter

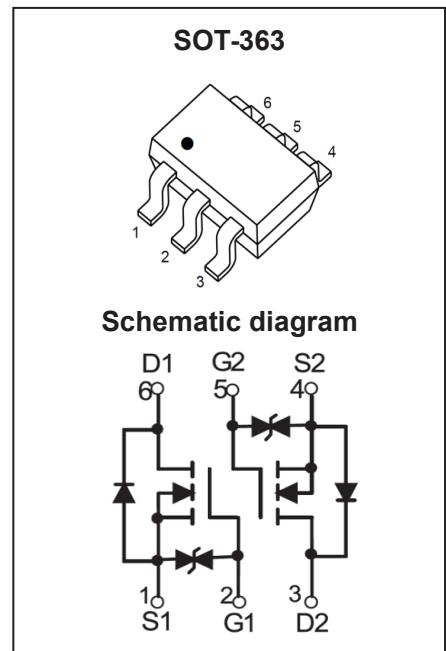
MARKING:



pin 1

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)

Parameter		Symbol	Value	Value	Unit
Drain - Source Voltage		V_{DS}	20	-20	V
Gate - Source Voltage		V_{GS}	± 10	± 10	V
Continuous Drain Current ^{1,5}	$T_C = 25^\circ C$	I_D	0.75	-0.66	A
Pulsed Drain Current ²		I_{DM}	1.8	-1.2	A
Power Dissipation ⁴	$T_C = 25^\circ C$	P_D	0.15		W
Thermal Resistance from Junction to Ambient ⁵		$R_{\theta JA}$	833		°C/W
Junction Temperature		T_J	150		°C
Storage Temperature		T_{STG}	-55~+150		°C



MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)
NMOS:

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 20\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			± 10	μA
On Characteristics³						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.4	0.7	1.0	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 4.5\text{V}, I_D = 0.65\text{A}$		170	260	$\text{m}\Omega$
		$V_{\text{GS}} = 2.5\text{V}, I_D = 0.55\text{A}$		230	360	
		$V_{\text{GS}} = 1.8\text{V}, I_D = 0.45\text{A}$		330	590	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		54.1		pF
Output Capacitance	C_{oss}			12.8		
Reverse Transfer Capacitance	C_{rss}			10.3		
Gate Resistance	R_g	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		56		Ω
Switching Characteristics						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 15\text{V}, V_{\text{GS}} = 4.5\text{V}, I_D = 0.5\text{A}, R_G = 10\Omega$		6.7		ns
Turn-on Rise Time	t_r			4.8		
Turn-off Delay Ttime	$t_{\text{d}(\text{off})}$			17.3		
Turn-off Fall Time	t_f			7.4		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = 0.5\text{A}$			1.2	V

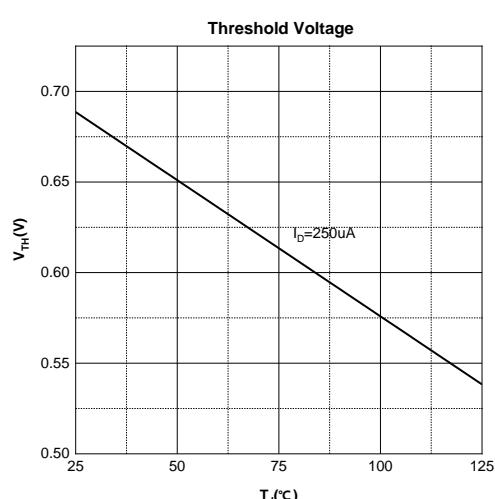
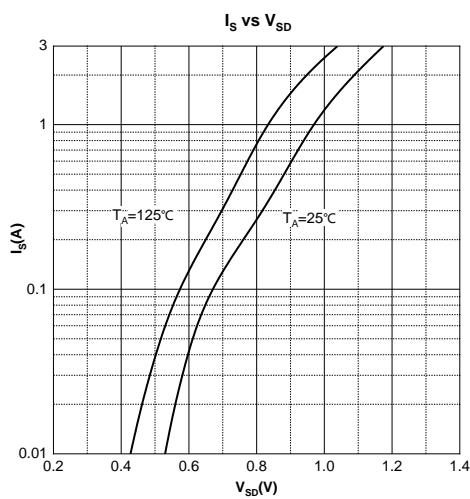
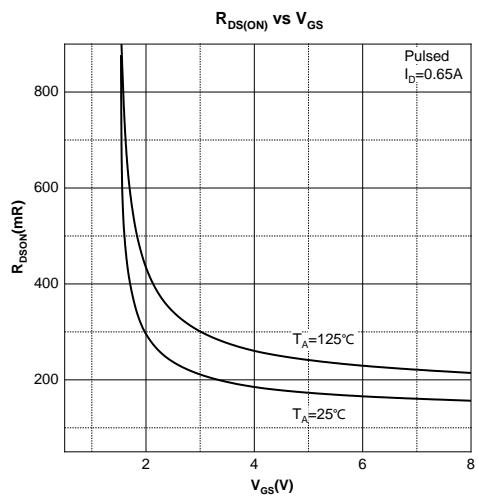
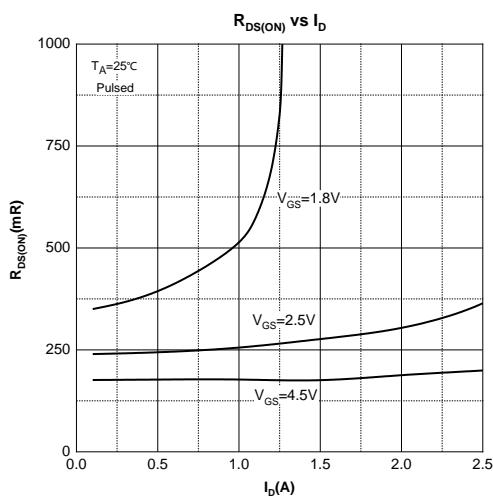
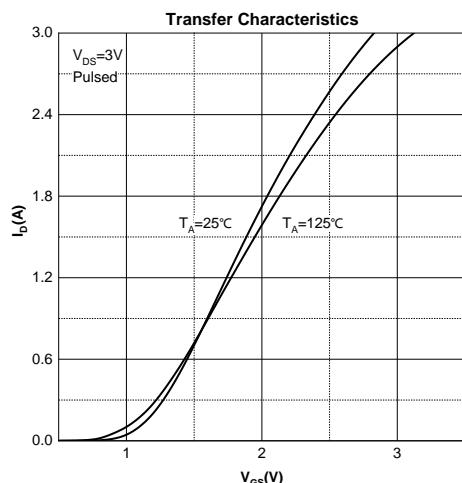
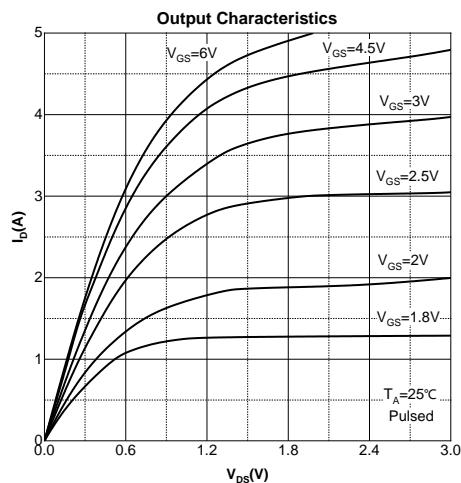
MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)
PMOS:

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -20\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 10\text{V}, V_{\text{DS}} = 0\text{V}$			± 10	nA
On Characteristics³						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.4	-0.7	-1.0	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -4.5\text{V}, I_D = -1\text{A}$		400	580	$\text{m}\Omega$
		$V_{\text{GS}} = -2.5\text{V}, I_D = -0.8\text{A}$		570	840	
		$V_{\text{GS}} = -1.8\text{V}, I_D = -0.5\text{A}$		810	1140	
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -10\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		76		pF
Output Capacitance	C_{oss}			14.6		
Reverse Transfer Capacitance	C_{rss}			12.2		
Gate Resistance	R_g	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		68		Ω
Switching Characteristics						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -10\text{V}, V_{\text{GS}} = -4.5\text{V}, I_D = -0.2\text{A}, R_G = 10\Omega$		9		ns
Turn-on Rise Time	t_r			5.7		
Turn-off Delay Ttime	$t_{\text{d}(\text{off})}$			32.6		
Turn-off Fall Time	t_f			20.3		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_s = -0.5\text{A}$			1.2	V

Notes :

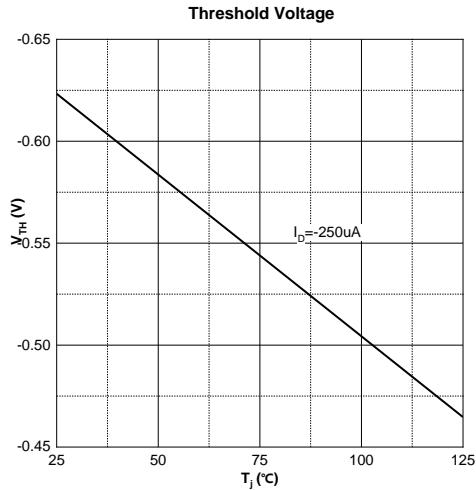
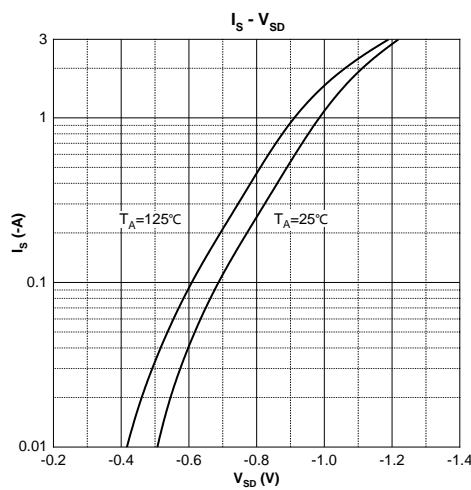
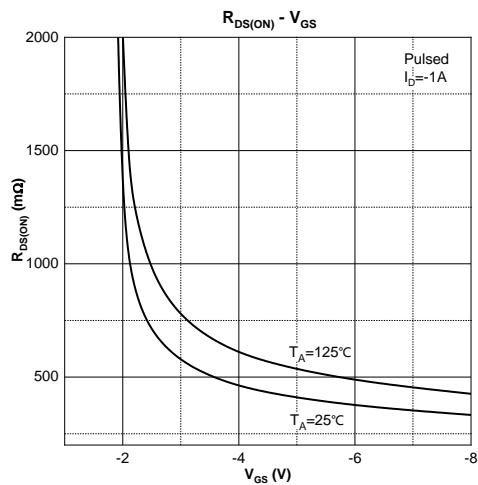
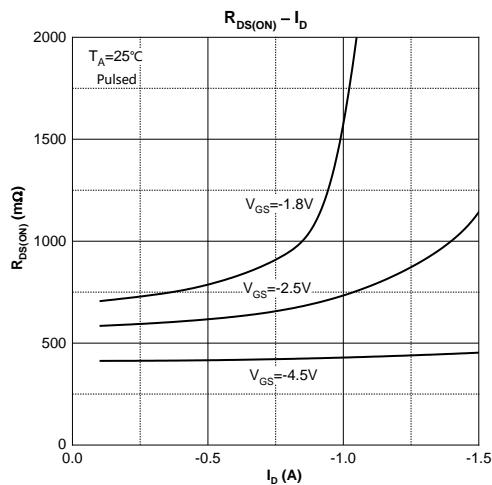
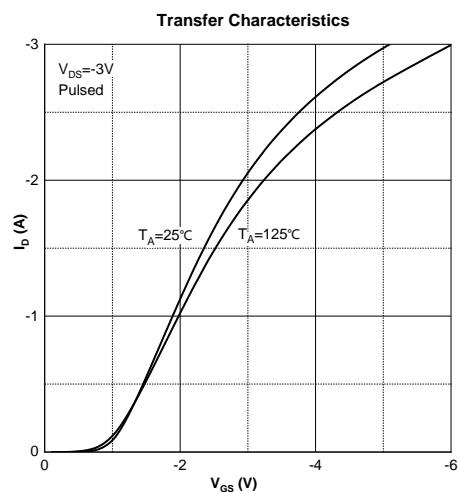
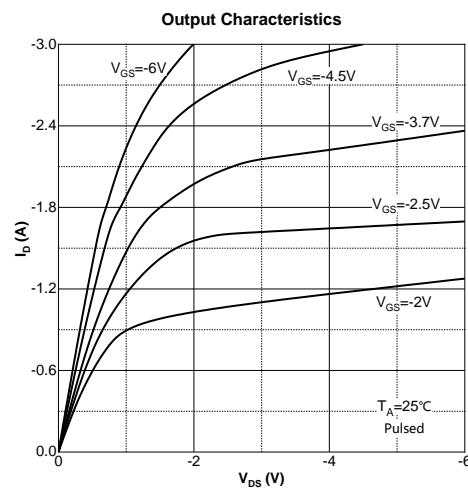
- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width $\leq 10\mu\text{s}$, duty cycle $\leq 1\%$.
- 3.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 4.The power dissipation P_D is limited by $T_{J(\text{MAX})} = 150^\circ\text{C}$.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

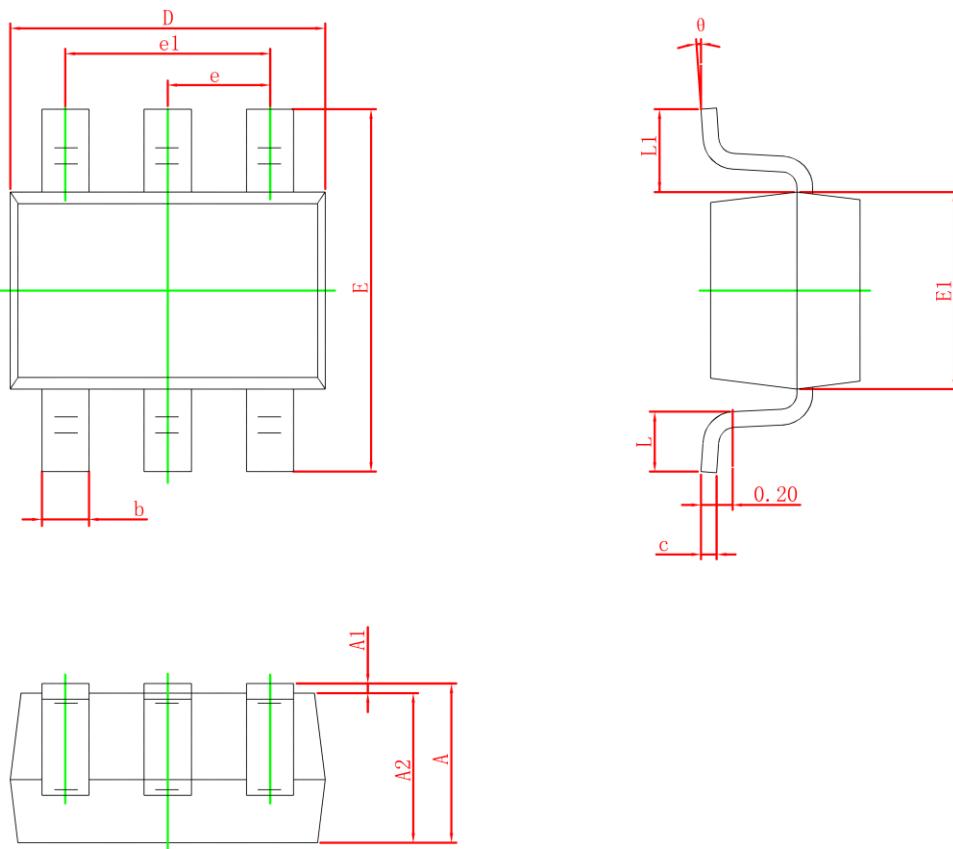
Typical Characteristics
NMOS:



Typical Characteristics

PMOS:



PDFN3.3x3.3-8L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A1	0	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	1.800	2.200	0.071	0.087
E	2.000	2.450	0.079	0.096
E1	1.150	1.350	0.045	0.053
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L1	0.525REF		0.021REF	
L	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°